

Marketing Bulletin

DATE: May 10, 2004
TO: Affected Customers
FROM: Mark Stoner
RE: Product Termination

To all concerned parties,

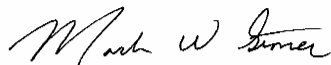
This bulletin is to notify all customers of the termination of the following Ecliptek series effective May 10th, 2004:

Series	Description	Recommended Replacement
EB51F2	5V 14 Pin DIP TCXO, HCMOS	None
ES51F2	5V 14 Pin DIP TCXO, Sinewave	None
EB52F2	3.3V 14 Pin DIP TCXO, HCMOS	None
ES52F2	3.3V 14 Pin DIP TCXO, Sinewave	None

Because of the circumstances surrounding this termination, there will be no end-of-life policy exercised. The series will be terminated with no purchasing or lifetime buy window available. We will however have a recommended alternative product for these series within the next ninety (90) days.

All of us at Ecliptek Corporation apologize for any inconvenience this may have caused and can assure you we are taking measures to insure this will not happen again in the future. If there are any questions pertaining to this bulletin, please feel free to contact me. Thank you for your cooperation.

Best Regards,



Mark W. Stoner
Director of Marketing
Ecliptek Corporation

STANDARD SPECIFICATIONS

Frequency Range:	1.544MHz to 44.736MHz
Frequency Tolerance/Stability:	
Initial Frequency Tolerance	±1ppm (at Nominal V _{DD} and V _C)
vs. Operating Temperature Range	See Table 1 for Maximum Values
vs. Input Voltage Change	±0.3ppm Maximum (V _{DD} ±5%)
vs. Load Change	±0.2ppm Maximum (±10%)
vs. Aging	±1ppm/year Maximum (@25°C)
Operating Temperature Range	See Table 1 for Operating Temperature Range
Storage Temperature Range	-55°C to +125°C
Supply Voltage (V _{DD})	5.0Vdc ±5%
Input Current (Steady State @25°C)	15mA Maximum ≤ 20.000MHz 30mA Maximum > 20.000MHz
Output Voltage Logic High	V _{DD} -0.5Vdc Minimum
Output Voltage Logic Low	0.5Vdc Maximum
Rise/Fall Time	6nSec (20% to 80% of waveform)
Duty Cycle	50% ±5% (@ 50% of waveform)
Load Drive Capability	30pF HCMOS Load
Phase Noise (Typical)	-60dBc/Hz at 10Hz Offset, -90dBc/Hz at 100Hz Offset, -125dBc/Hz at 1kHz Offset, -135dBc/Hz at 10kHz Offset, -140dBc/Hz at 100kHz Offset,
Frequency Deviation	±7ppm Minimum, ±20ppm Maximum (Referenced to F ₀ at V _C =2.5Vdc; V _{DD} =5.0Vdc)
Control Voltage Range (V _{CR})	0.0Vdc to V _{DD}
Control Voltage / Transfer Function	2.5Vdc ±2.0Vdc / Positive Transfer Characteristic
Linearity	±10% Maximum
Input Impedance	10kOhms Typical

OBSOLETE

ENVIRONMENTAL & MECHANICAL

Fine Leak Test:	MIL-STD-883, Method 1014, Condition A	Solderability:	MIL-STD-883, Method 2002
Gross Leak Test:	MIL-STD-883, Method 1014, Condition C	Temperature Cycling:	MIL-STD-883, Method 1010
Mechanical Shock:	MIL-STD-202, Method 213, Condition C	Resistance to Soldering Heat:	MIL-STD-202, Method 210
Vibration:	MIL-STD-883, Method 2007, Condition A	Resistance to Solvents:	MIL-STD-202, Method 215
Lead Integrity:	MIL-STD-883, Method 2004		

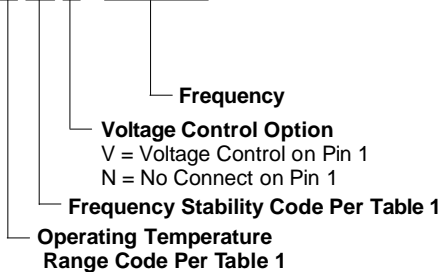
TABLE 1: PART NUMBERING CODES

Range	Code	FREQUENCY STABILITY				Code
		15	20	30	50	
		±1.5ppm	±2.0ppm	±3.0ppm	±5.0ppm	Range
0°C to +50°C	A	Y	Y	Y	Y	
0°C to +70°C	B	X	Y	Y	Y	
-20°C to +70°C	C	X	X	Y	Y	
-30°C to +75°C	D		X	Y	Y	
-40°C to +85°C	E			X	Y	

X Denotes availability from 1.544MHz to 32.768MHz
Y Denotes availability for any valid frequency

PART NUMBERING GUIDE

EB51F2 A 10 V - 20.000M



MARKING GUIDE

(Line #1) **ECLIPTEK**

(Line #2) **XX.XXXM**

(Line #3) **XX Y ZZ**

Frequency

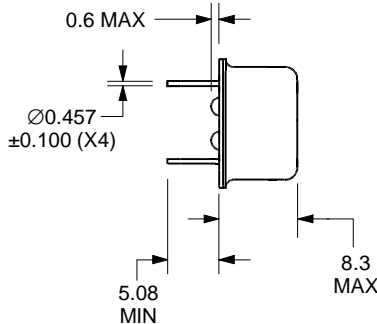
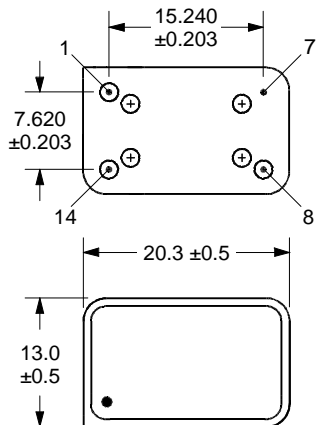
Week of Year

Last Digit of Year

Ecliptek Manufacturing Code (TEN02-001-000)



NOTE: Pin 1 shall be marked with a dot. Marking shall conform to conditions listed in TQC41-001-000.



ALL DIMENSIONS
IN MILLIMETERS

PIN	CONNECTION
1	No Connect or Voltage Control
7	Ground/Case Ground
8	Output
14	Supply Voltage

SPECIFICATION CONTROL DRAWING

	Drawing Number CSC26-140-001
Title 5.0V Full Size (VC)TCXO	
Revision A	Effectivity Date 09-09-03
ECN Number 8159	PAGE 1 OF 2
Approved By	Date
Released By	Date

STANDARD SPECIFICATIONS

Frequency Range:	9.600MHz to 44.736MHz
Frequency Tolerance/Stability:	<div style="border: 2px solid red; padding: 10px; font-size: 2em; font-weight: bold; color: red;">OBSOLETE</div>
Initial Frequency Tolerance vs. Operating Temperature Range vs. Input Voltage Change vs. Load Change vs. Aging	
Operating Temperature Range	
Storage Temperature Range	
Supply Voltage (VDD)	
Input Current (Steady State @25°C)	10mA Maximum
Output Voltage	1.0Vp-p Minimum Clipped Sinewave
Load Drive Capability	10kOhms//10pF
Phase Noise (Typical)	-60dBc/Hz at 10Hz Offset, -90dBc/Hz at 100Hz Offset, -125dBc/Hz at 1kHz Offset, -135dBc/Hz at 10kHz Offset, -140dBc/Hz at 100kHz Offset
Frequency Deviation	±7ppm Minimum, ±20ppm Maximum (Referenced to Fo at Vc=2.5Vdc; Vdd=5.0Vdc)
Control Voltage Range (VCR)	0.0Vdc to VDD
Control Voltage / Transfer Function	2.5Vdc ±2.0Vdc / Positive Transfer Characteristic
Linearity	±10% Maximum
Input Impedance	10kOhms Typical

ENVIRONMENTAL & MECHANICAL

Fine Leak Test:	MIL-STD-883, Method 1014, Condition A	Solderability:	MIL-STD-883, Method 2002
Gross Leak Test:	MIL-STD-883, Method 1014, Condition C	Temperature Cycling:	MIL-STD-883, Method 1010
Mechanical Shock:	MIL-STD-202, Method 213, Condition C	Resistance to Soldering Heat:	MIL-STD-202, Method 210
Vibration:	MIL-STD-883, Method 2007, Condition A	Resistance to Solvents:	MIL-STD-202, Method 215
Lead Integrity:	MIL-STD-883, Method 2004		

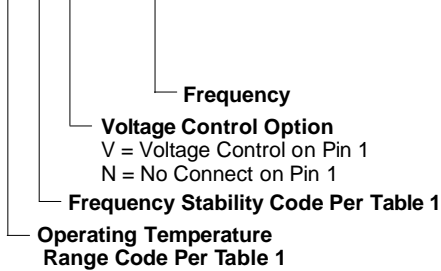
TABLE 1: PART NUMBERING CODES

OPERATING TEMPERATURE		FREQUENCY STABILITY				Code Range
		15	20	30	50	
Range	Code	±1.5ppm	±2.0ppm	±3.0ppm	±5.0ppm	
0°C to +50°C	A	Y	Y	Y	Y	
0°C to +70°C	B	X	Y	Y	Y	
-20°C to +70°C	C		X	Y	Y	
-30°C to +75°C	D			Y	Y	
-40°C to +85°C	E			X	Y	

X Denotes availability from 9.600MHz to 32.768MHz
Y Denotes availability for any valid frequency

PART NUMBERING GUIDE

ES51F2 A 10 V - 20.000M



MARKING GUIDE

(Line #1) **ECLIPTEK**

(Line #2) **XX.XXXM**

Frequency

(Line #3) **XX Y ZZ**

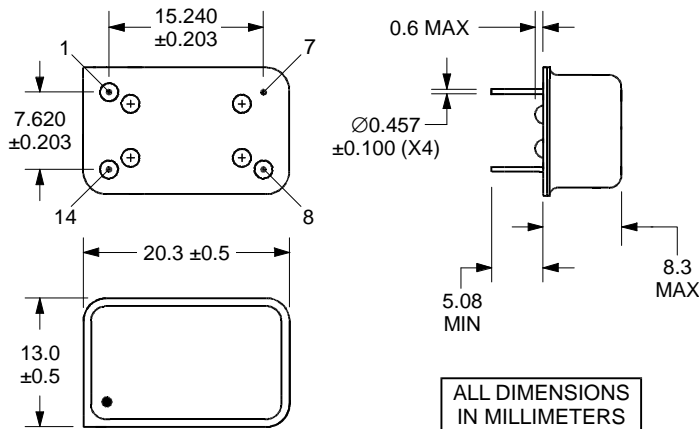
Week of Year

Last Digit of Year

Ecliptek Manufacturing Code (TEN02-001-000)



NOTE: Pin 1 shall be marked with a dot. Marking shall conform to conditions listed in TQC41-001-000.



PIN	CONNECTION
1	No Connect or Voltage Control
7	Ground/Case Ground
8	Output
14	Supply Voltage

SPECIFICATION CONTROL DRAWING

	Drawing Number CSC26-160-001
Title 5.0V Clipped Sinewave Full Size (VC)TCXO	
Revision A	Effectivity Date 09-09-03
ECN Number 8163	PAGE 1 OF 2
Approved By	Date
Released By	Date

STANDARD SPECIFICATIONS

OBSOLETE

Frequency Range:	1.544MHz to 44.736MHz
Frequency Tolerance/Stability:	±1ppm (at Nominal Vdd and Vc)
Initial Frequency Tolerance vs. Operating Temperature Range vs. Input Voltage Change vs. Load Change vs. Aging	See Table 1 for Maximum Values ±0.3ppm Maximum (VDD ±5%) ±0.2ppm Maximum (±10%) ±1ppm/year Maximum (@25°C)
Operating Temperature Range	See Table 1 for Operating Temperature Range
Storage Temperature Range	-55°C to +125°C
Supply Voltage (VDD)	3.3Vdc ±5%
Input Current (Steady State @25°C)	15mA Maximum ≤ 20.000MHz 25mA Maximum > 20.000MHz
Output Voltage Logic High	90% of Vdd Minimum
Output Voltage Logic Low	10% of Vdd Maximum
Rise/Fall Time	6nSec (20% to 80% of waveform)
Duty Cycle	50% ±5% (@ 50% of waveform)
Load Drive Capability	15pF HCMOS Load
Phase Noise (Typical)	-60dBc/Hz at 10Hz Offset, -90dBc/Hz at 100Hz Offset, -125dBc/Hz at 1kHz Offset, -135dBc/Hz at 10kHz Offset, -140dBc/Hz at 100kHz Offset,
Frequency Deviation	±7ppm Minimum, ±20ppm Maximum (Referenced to Fo at Vc=1.65Vdc; Vdd=3.3Vdc)
Control Voltage Range (VCR)	0.0Vdc to VDD
Control Voltage / Transfer Function	1.65VDC ±1.35VDC / Positive Transfer Characteristic
Linearity	±10% Maximum
Input Impedance	10kOhms Typical

ENVIRONMENTAL & MECHANICAL

Fine Leak Test:	MIL-STD-883, Method 1014, Condition A	Solderability:	MIL-STD-883, Method 2002
Gross Leak Test:	MIL-STD-883, Method 1014, Condition C	Temperature Cycling:	MIL-STD-883, Method 1010
Mechanical Shock:	MIL-STD-202, Method 213, Condition C	Resistance to Soldering Heat:	MIL-STD-202, Method 210
Vibration:	MIL-STD-883, Method 2007, Condition A	Resistance to Solvents:	MIL-STD-202, Method 215
Lead Integrity:	MIL-STD-883, Method 2004		

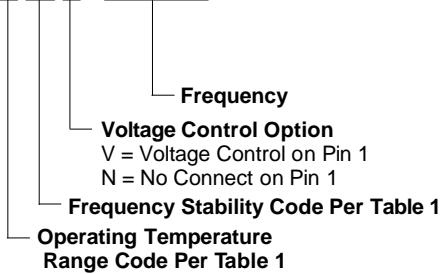
TABLE 1: PART NUMBERING CODES

Range	Code	FREQUENCY STABILITY				Code
		15 ±1.5ppm	20 ±2.0ppm	30 ±3.0ppm	50 ±5.0ppm	
0°C to +50°C	A	Y	Y	Y	Y	
0°C to +70°C	B	X	Y	Y	Y	
-20°C to +70°C	C		X	Y	Y	
-30°C to +75°C	D			Y	Y	
-40°C to +85°C	E			X	Y	

X Denotes availability from 1.544MHz to 32.768MHz
Y Denotes availability for any valid frequency

PART NUMBERING GUIDE

EB52F2 A 10 V - 20.000M



MARKING GUIDE

(Line #1) **ECLIPTEK**

(Line #2) **XX.XXXM**

(Line #3) **XX Y ZZ**

Frequency

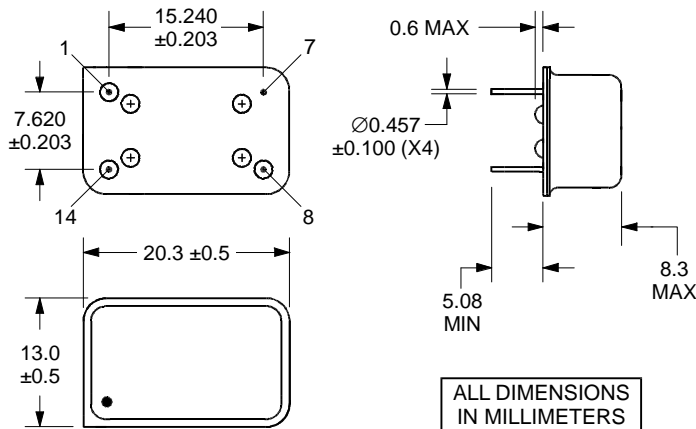
Week of Year

Last Digit of Year

Ecliptek Manufacturing Code (TEN02-001-000)



NOTE: Pin 1 shall be marked with a dot. Marking shall conform to conditions listed in TQC41-001-000.



PIN	CONNECTION
1	No Connect or Voltage Control
7	Ground/Case Ground
8	Output
14	Supply Voltage

SPECIFICATION CONTROL DRAWING

	Drawing Number CSC26-150-001
Title 3.3V FULL SIZE (VC)TCXO	
Revision A	Effectivity Date 09-09-03
ECN Number 8161	PAGE 1 OF 2
Approved By	Date
Released By	Date

STANDARD SPECIFICATIONS

Frequency Range:	9.600MHz to 44.736MHz
Frequency Tolerance/Stability:	<div style="border: 2px solid red; padding: 10px; font-size: 2em; color: red; font-weight: bold;">OBSOLETE</div>
Initial Frequency Tolerance	
vs. Operating Temperature Range	
vs. Input Voltage Change	
vs. Load Change	
vs. Aging	±1ppm/year Maximum (@25°C)
Operating Temperature Range	See Table 1 for Operating Temperature Range
Storage Temperature Range	-55°C to +125°C
Supply Voltage (VDD)	3.3Vdc ±5%
Input Current (Steady State @25°C)	10mA Maximum
Output Voltage	0.7Vp-p Minimum Clipped Sinewave
Load Drive Capability	10kOhms//10pF
Phase Noise (Typical)	-60dBc/Hz at 10Hz Offset, -90dBc/Hz at 100Hz Offset, -125dBc/Hz at 1kHz Offset, -135dBc/Hz at 10kHz Offset, -140dBc/Hz at 100kHz Offset
Frequency Deviation	±7ppm Minimum, ±20ppm Maximum (Referenced to Fo at Vc=1.65Vdc; Vdd=3.3Vdc)
Control Voltage Range (VCR)	0.0Vdc to VDD
Control Voltage / Transfer Function	1.65Vdc ±1.35Vdc / Positive Transfer Characteristic
Linearity	±10% Maximum
Input Impedance	10kOhms Typical

ENVIRONMENTAL & MECHANICAL

Fine Leak Test:	MIL-STD-883, Method 1014, Condition A	Solderability:	MIL-STD-883, Method 2002
Gross Leak Test:	MIL-STD-883, Method 1014, Condition C	Temperature Cycling:	MIL-STD-883, Method 1010
Mechanical Shock:	MIL-STD-202, Method 213, Condition C	Resistance to Soldering Heat:	MIL-STD-202, Method 210
Vibration:	MIL-STD-883, Method 2007, Condition A	Resistance to Solvents:	MIL-STD-202, Method 215
Lead Integrity:	MIL-STD-883, Method 2004		

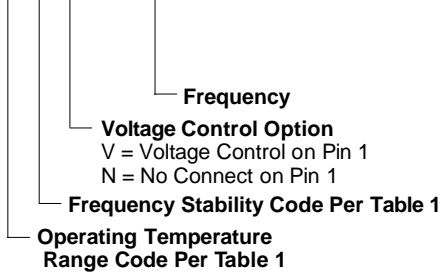
TABLE 1: PART NUMBERING CODES

OPERATING TEMPERATURE		FREQUENCY STABILITY				Code Range
		15	20	30	50	
Range	Code	±1.5ppm	±2.0ppm	±3.0ppm	±5.0ppm	
0°C to +50°C	A	Y	Y	Y	Y	
0°C to +70°C	B	X	Y	Y	Y	
-20°C to +70°C	C		X	Y	Y	
-30°C to +75°C	D			Y	Y	
-40°C to +85°C	E			X	Y	

X Denotes availability from 9.600MHz to 32.768MHz
Y Denotes availability for any valid frequency

PART NUMBERING GUIDE

ES52F2 A 10 V - 20.000M



MARKING GUIDE

(Line #1) **ECLIPTEK**

(Line #2) **XX.XXXM**

Frequency

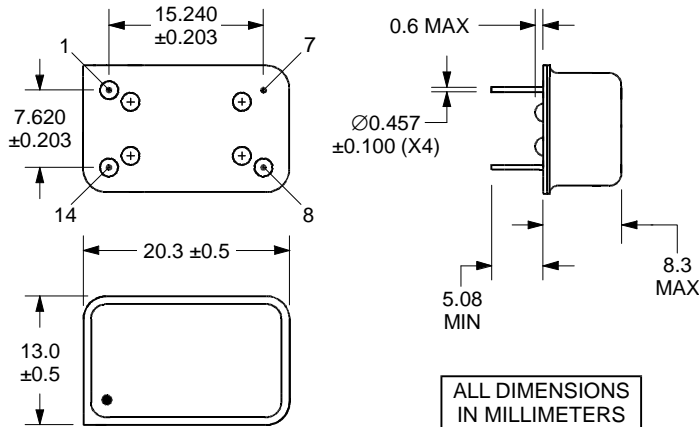
(Line #3) **XX Y ZZ**

Week of Year
Last Digit of Year

Eclipse Manufacturing Code (TEN02-001-000)



NOTE: Pin 1 shall be marked with a dot. Marking shall conform to conditions listed in TQC41-001-000.



PIN	CONNECTION
1	No Connect or Voltage Control
7	Ground/Case Ground
8	Output
14	Supply Voltage

SPECIFICATION CONTROL DRAWING

	Drawing Number CSC26-170-001
Title 3.3V Clipped Sinewave Full Size (VC)TCXO	
Revision A	Effectivity Date 09-09-03
ECN Number 8165	PAGE 1 OF 2
Approved By	Date
Released By	Date